Applicable	e standard							
	Operating		-35°C to +85°C(Note 1)		•	-10°C to +60°C(Note		
Rating	temperature range				perature range	,		
	Operating		20 % to 80 % (Note 2) Stora		=	40 % to 70 %(Note 3)		
	humidity range				idity range icable	DE40 *DC 4 050		
	Voltage		- ( - )		nector	DF13-*DS-1.25C		
	Current		1 A Applic		icable	DF13(G)-2630SCF/ DF13-3032SCFA		
					act			
			Specifica	ations	5			
Item		Test method			Requirements			AT
Construc	tion	1				-		
General exar	nination	Visually and by measuring instrument.		According to drawing.			Χ	
Marking		Confirmed visually.			-	X	Х	
Flectric o	haracteris	tics	-				1 /	
Contact resis					30 mΩ MAX.			_
Insulation res	sistance	100 V DC.			500 MΩ MIN.			_
Voltage proof		500 V AC for 1 min.			No flashover or breakdown.			_
	cal charact	eristics					X	
		50 times insertions and extractions.		<ol> <li>Contact resistance: 30 mΩ MAX.</li> <li>No damage, crack or looseness of parts.</li> </ol>			1	
		of times insertions and extractions.					_	
Vibration Shock		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 2 h, for 3 directions.			<ol> <li>No electrical discontinuity of 1µs.</li> <li>No damage, crack or looseness of parts.</li> </ol>			_
		490 m/s <sup>2</sup> duration of pulse 11 ms at 3 times for 3			(2) No damage, cra	X		
		directions					_	
Environm	nental char	acterist	tics					
Rapid change	e of	Tempera	ture -55 → 15 to 35 → +85 → 15 to 35 °c		① Contact resistan	ce: 30mΩ MAX.		
temperature		Time $30 \rightarrow 2$ to $3 \rightarrow 30 \rightarrow 2$ to 3 min. Under 5 cycles.			② Insulation resistance: 500 MΩ MIN.			-
					3 No damage, crae			
Damp heat		Exposed at 40 ± 2 °c, 90 to 95 %, 96 h.					Х	_
(Steady state	<u>*                                      </u>							
heat		1) Reflow soldering  ≪Reflow area≫  250°C MAX  10 sec MAX			No deformation of case of excessive looseness of the terminals.			_
			230°C MIN 60 sec MAX ≪Preheating area≫					
			C to 190°C 60 sec to 120 sec					
			hrough in reflow furnace twice,					
		leave in ambient temperature and humidity for 1 hour.  2) Manual soldering Soldering iron temperature :300°C,						
			ng time : 3sec.					
		0.11			ength on contact.		2	
Solderability		Soldered at solder temperature,		Solder shall cover a minimum of 95 % of the surface being immersed.				
		245°C for	insertion duration, 3sec.		95 % of the surface	e being immersed.		

## Remarks

Note 1: Include the temperature rising by current.

Note 2: No condensing

Note 3: Apply to the condition of long term storage for unused products before mounted on PCB.

After mounted on PCB board, operating temperature and humidity range is applied for interim storage during transportation.

	Count	Description of revisions	Designed			Checked		Date		
$\Delta$	4									
Unless otherwise specified, refer to IEC 60512.				Approved			HS.OKAWA	18.04.05		
					Checked		1	TS.FUKUSHIMA	18.04.05	
					Designed			TS.KUMAZAWA	18.04.05	
					Drawn			MK.INOUE	18.04.05	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				Drawing no.			ELC-367982-76-00			
HS.		Specification sheet		P	Part no. DF		DF	F13EA-*DP-1.25V(76)		
		Hirose electric co., ltd.			Code no.		(	CL536		1/1